

Product data sheet

1. General description

P-channel enhancement mode Field-Effect Transistor (FET) in a leadless medium power DFN2020MD-6 (SOT1220) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

2. Features and benefits

- Low threshold voltage
- Trench MOSFET technology
- Side wettable flanks for optical solder inspection
- ElectroStatic Discharge (ESD) protection > 2 kV HBM (class H2)
- AEC-Q101 qualified

3. Applications

- Relay driver
- High-speed line driver
- High-side load switch
- Switching circuits

4. Quick reference data

Table 1. Quick reference data							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-	-20	V
V _{GS}	gate-source voltage			-12	-	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-	-5	А
Static characteristics							
R _{DSon}	drain-source on-state resistance	V _{GS} = -4.5 V; I _D = -5 A; T _j = 25 °C		-	28	32.5	mΩ

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm².

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5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	D	drain		D
2	D	drain		
3	G	gate		G ↓ ↓ ↓
4	S	source		
5	D	drain	Transparent top view	
6	D	drain	DFN2020MD-6 (SOT1220)	s S
7	D	drain		017aaa259
8	S	source		

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PMPB29XPEA	DFN2020MD-6	DFN2020MD-6: plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals	SOT1220		

7. Marking

Table 4. Marking codes

Type number	Marking code
PMPB29XPEA	4L

8. Limiting values

 Table 5. Limiting values

 In accordance with the Absolute Maximum Rating System (IEC 60134).

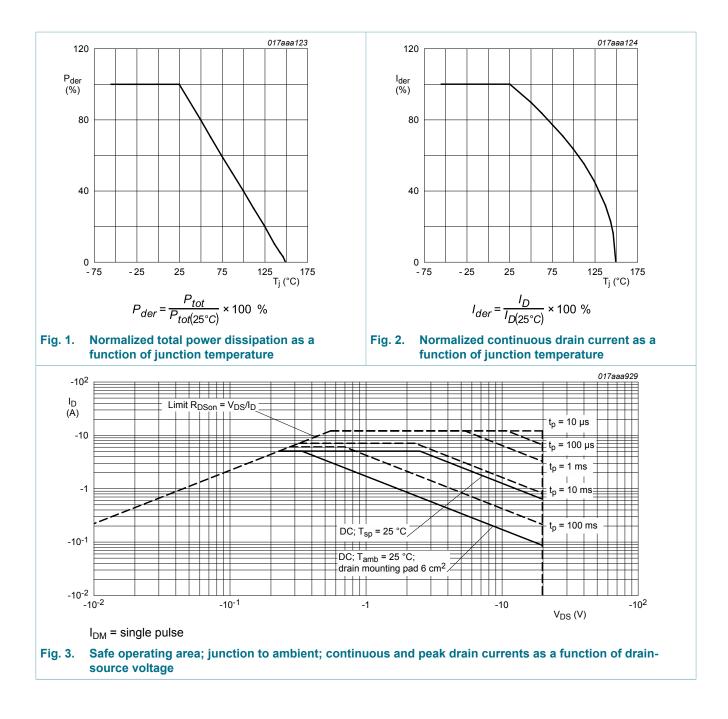
Symbol	Parameter	Conditions		Min	Max	Unit
V _{DS}	drain-source voltage	T _j = 25 °C		-	-20	V
V _{GS}	gate-source voltage			-12	12	V
I _D	drain current	V _{GS} = -4.5 V; T _{amb} = 25 °C	[1]	-	-5	А
		V _{GS} = -4.5 V; T _{amb} = 100 °C	[1]	-	-3.2	А
I _{DM}	peak drain current	T_{amb} = 25 °C; single pulse; $t_p \le 10 \ \mu s$		-	-12	А
P _{tot}	total power dissipation	T _{amb} = 25 °C	[1]	-	1.7	W
		T _{sp} = 25 °C		-	12.5	W
Tj	junction temperature			-55	150	°C
T _{amb}	ambient temperature			-55	150	°C
T _{stg}	storage temperature			-65	150	°C
Source-drai	n diode					
I _S	source current	T _{amb} = 25 °C	[1]	-	-1.8	А
ESD maxim	um rating					
V _{ESD}	electrostatic discharge voltage	НВМ	[2]	-	2000	V
Avalanche r	uggedness	·				
E _{DS(AL)S}	non-repetitive drain- source avalanche energy	$T_{j(init)}$ = 25 °C; I _D = -2.1 A; DUT in avalanche (unclamped)		-	22.1	mJ

Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 6 cm². [1]

Measured between all pins. [2]

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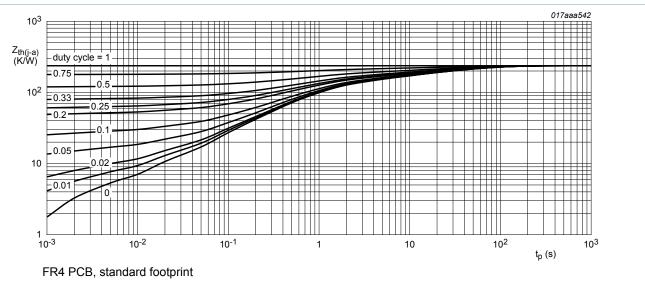
9. Thermal characteristics

Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1]	-	235	270	K/W
			[2]	-	67	74	K/W
R _{th(j-sp)}	thermal resistance from junction to solder point			-	5	10	K/W

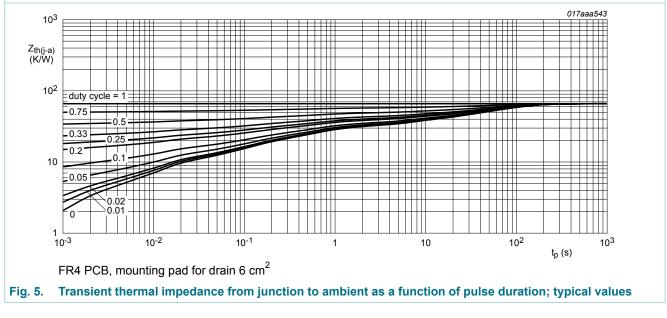
Table 6 Thermal characteristics

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain 6 cm².







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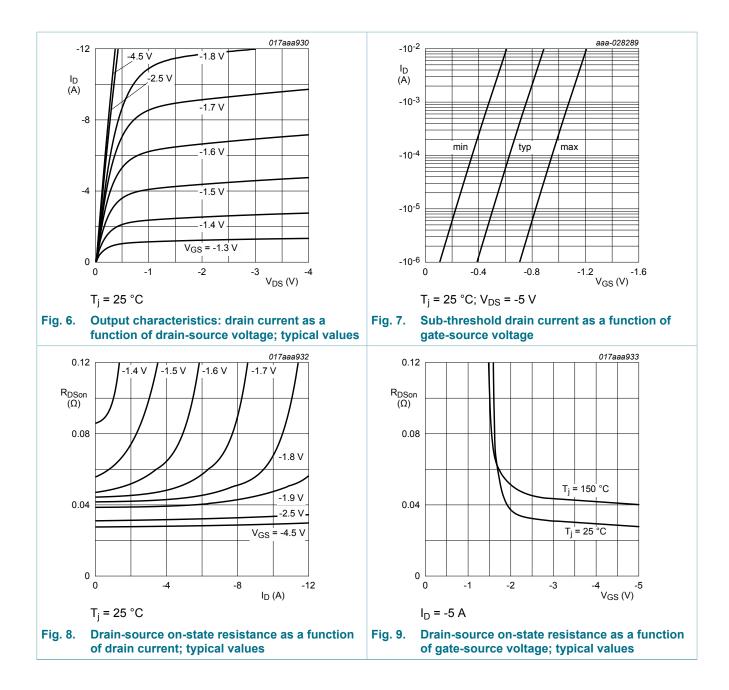
10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	acteristics			1		
V _{(BR)DSS}	drain-source breakdown voltage	I_D = -250 µA; V_{GS} = 0 V; T_j = 25 °C	-20	-	-	V
V _{GSth}	gate-source threshold voltage	I_D = -250 µA; V_{DS} = V_{GS} ; T_j = 25 °C	-0.4	-0.7	-1	V
I _{DSS}	drain leakage current	V_{DS} = -20 V; V_{GS} = 0 V; T_j = 25 °C	-	-	-1	μA
I _{GSS} g	gate leakage current	V _{GS} = -8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	-10	μA
		V _{GS} = 8 V; V _{DS} = 0 V; T _j = 25 °C	-	-	10	μA
R _{DSon}	drain-source on-state	V _{GS} = -4.5 V; I _D = -5 A; T _j = 25 °C	-	28	32.5	mΩ
	resistance	V _{GS} = -4.5 V; I _D = -5 A; T _j = 150 °C	-	39	46	mΩ
		V_{GS} = -2.5 V; I _D = -5 A; T _j = 25 °C	-	31	38	mΩ
		V _{GS} = -1.8 V; I _D = -3.7 A; T _j = 25 °C	-	36	48	mΩ
9 _{fs}	forward transconductance	V _{DS} = -10 V; I _D = -5 A; T _j = 25 °C	-	20	-	S
R _G	gate resistance	f = 1 MHz	-	5.3	-	Ω
Dynamic ch	naracteristics			1		
Q _{G(tot)}	total gate charge	V_{DS} = -10 V; I _D = -5 A; V _{GS} = -4.5 V;	-	30	45	nC
Q _{GS}	gate-source charge	T _j = 25 °C	-	4.3	-	nC
Q _{GD}	gate-drain charge		-	7	-	nC
C _{iss}	input capacitance	$V_{DS} = -10 \text{ V}; \text{ f} = 1 \text{ MHz}; \text{ V}_{GS} = 0 \text{ V};$	-	2970	-	pF
C _{oss}	output capacitance	T _j = 25 °C	-	245	-	pF
C _{rss}	reverse transfer capacitance		-	210	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = -10 V; I_{D} = -5 A; V_{GS} = -4.5 V;	-	12	-	ns
t _r	rise time	$R_{G(ext)} = 6 \Omega; T_j = 25 °C$	-	53	-	ns
t _{d(off)}	turn-off delay time		-	91	-	ns
t _f	fall time		-	46	-	ns
Source-drai	in diode					
V _{SD}	source-drain voltage	I _S = -1.8 A; V _{GS} = 0 V; T _j = 25 °C	-	-0.7	-1.2	V
t _{rr}	reverse recovery time	$I_{S} = -1.8 \text{ A}; dI_{S}/dt = 100 \text{ A}/\mu\text{s};$	-	33	-	ns
Q _r	recovered charge	V _{GS} = 0 V; V _{DS} = -10 V; T _j = 25 °C	-	21	-	nC

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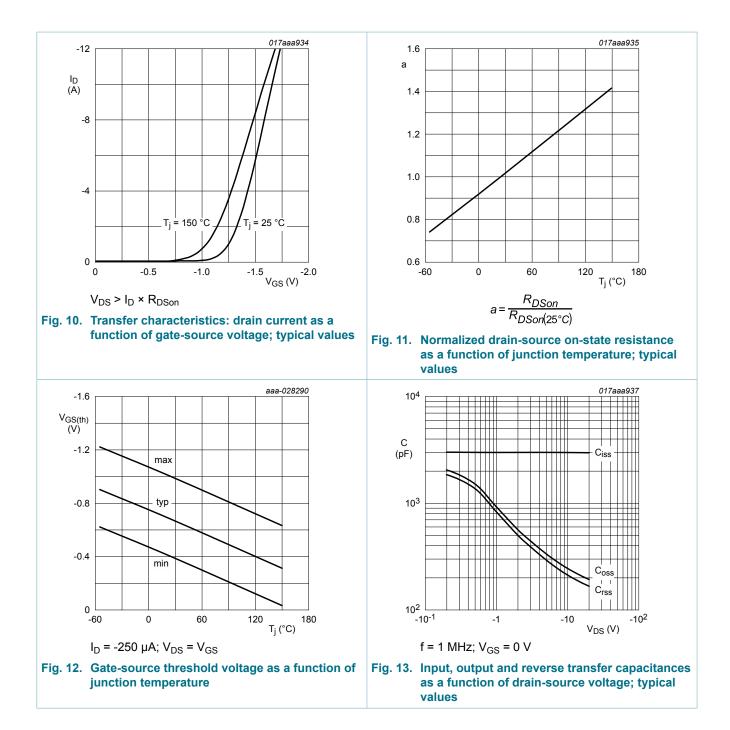
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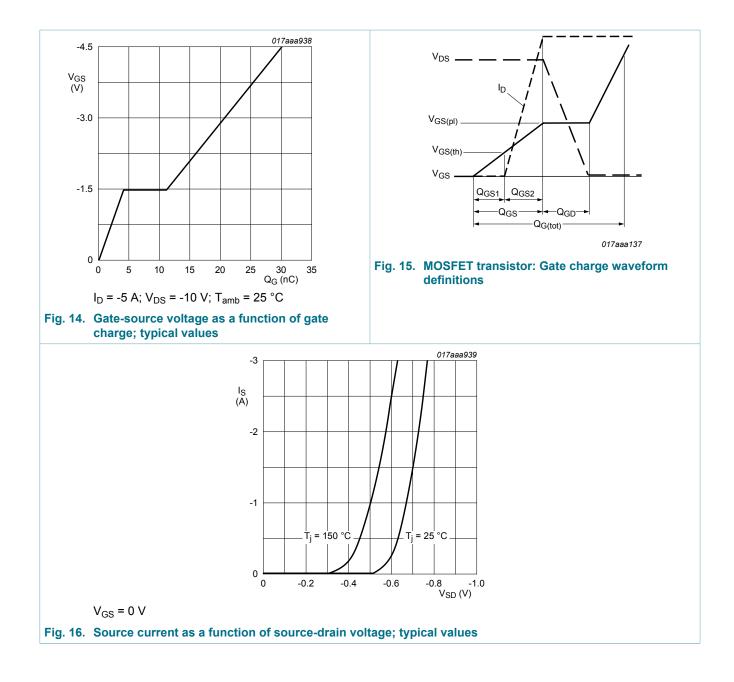
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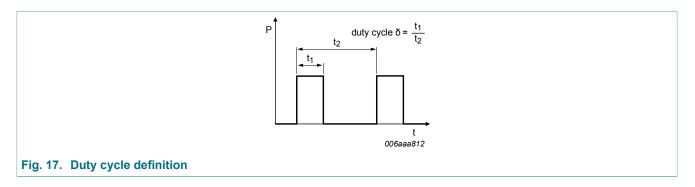
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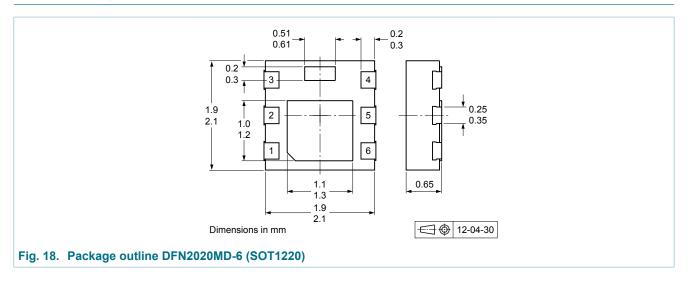
11. Test information



Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

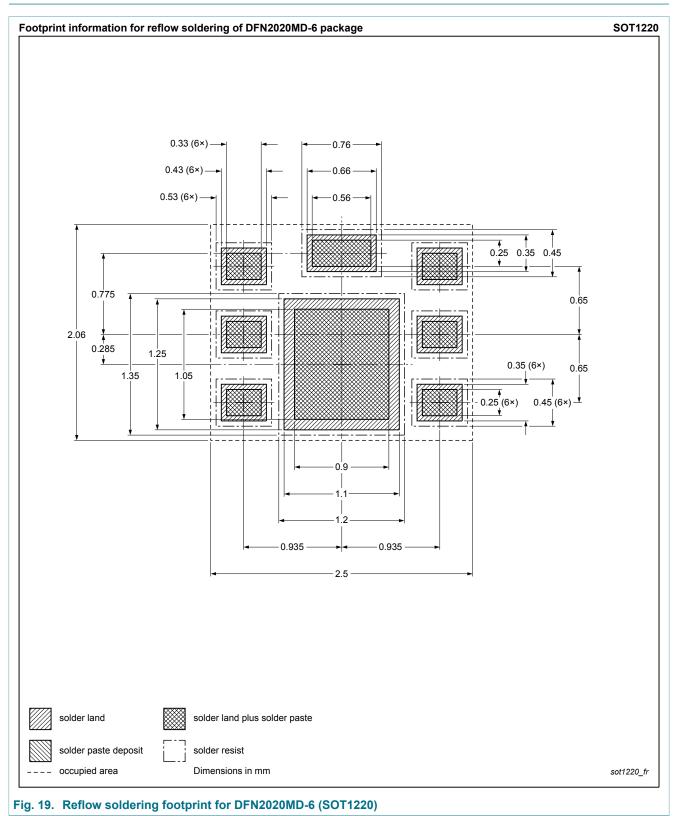
12. Package outline



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13. Soldering



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14. Revision history

Table 8. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMPB29XPEA v.1	20180327	Product data sheet	-	-			

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15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

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